400KHz 60V 2A Switching Current Boost LED Constant Current Driver XL6013

Features

- Wide 5V to 40V Input Voltage Range
- 0.22V FB adjustable LED drive current
- Directly drive 2~10 Series 1W LED
- Fixed 400KHz Switching Frequency
- Max. 2A Switching Current Capability
- SW PIN Built in Over Voltage Protection
- Up to 93% efficiency
- Excellent line and load regulation
- EN PIN TTL shutdown capability
- Internal Optimize Power MOSFET
- Built in Soft-Start Function
- Built in Frequency Compensation
- Built in Thermal Shutdown Function
- Built in Current Limit Function
- Available in SOP8L package

Applications

- LED Lighting
- Boost constant current driver
- Monitor LED Backlighting
- 7’ to 15’ LCD Panels

General Description

The XL6013 regulator is fixed frequency PWM Boost (step-up) LED constant current driver, capable of driving Series 1W LED units with excellent line and load regulation. The regulator is simple to use because it includes internal frequency compensation and a fixed-frequency oscillator so that it requires a minimum number of external components to work.

The XL6013 could directly drive 5~10 Series 1W LED units at VIN>12V .

The PWM control circuit is able to adjust the duty ratio linearly from 0 to 90%. An enable function, an over current protection function is built inside. An internal compensation block is built in to minimize external component count.

Figure1. Package Type of XL6013

Pin Configurations

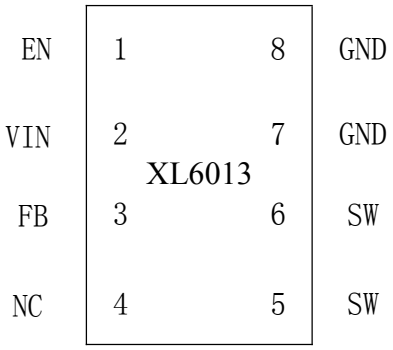


Figure2. Pin Configuration of XL6013 (Top View)

Table 1 Pin Description

Pin Number	Pin Name	Description
1	EN	Enable Pin. Drive EN pin low to turn off the device, drive it high to turn it on. Floating is default high.
2	VIN	Supply Voltage Input Pin. XL6013 operates from a 5V to 40V DC voltage. Bypass Vin to GND with a suitably large capacitor to eliminate noise on the input.
3	FB	Feedback Pin (FB). The feedback threshold voltage is 0.22V.
4	NC	No Connected.
5,6	SW	Power Switch Output Pin (SW). Output is the switch node that supplies power to the output.
7,8	GND	Ground Pin.

Function Block

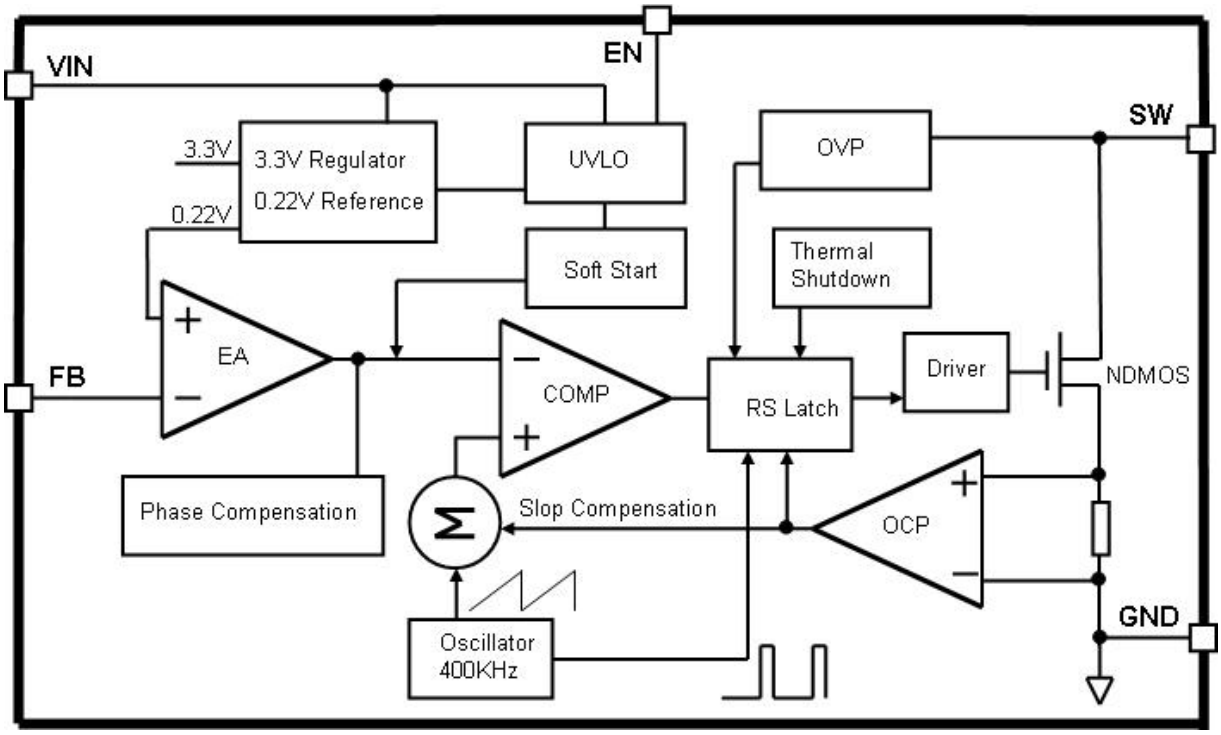


Figure3. Function Block Diagram of XL6013

Typical Application Circuit

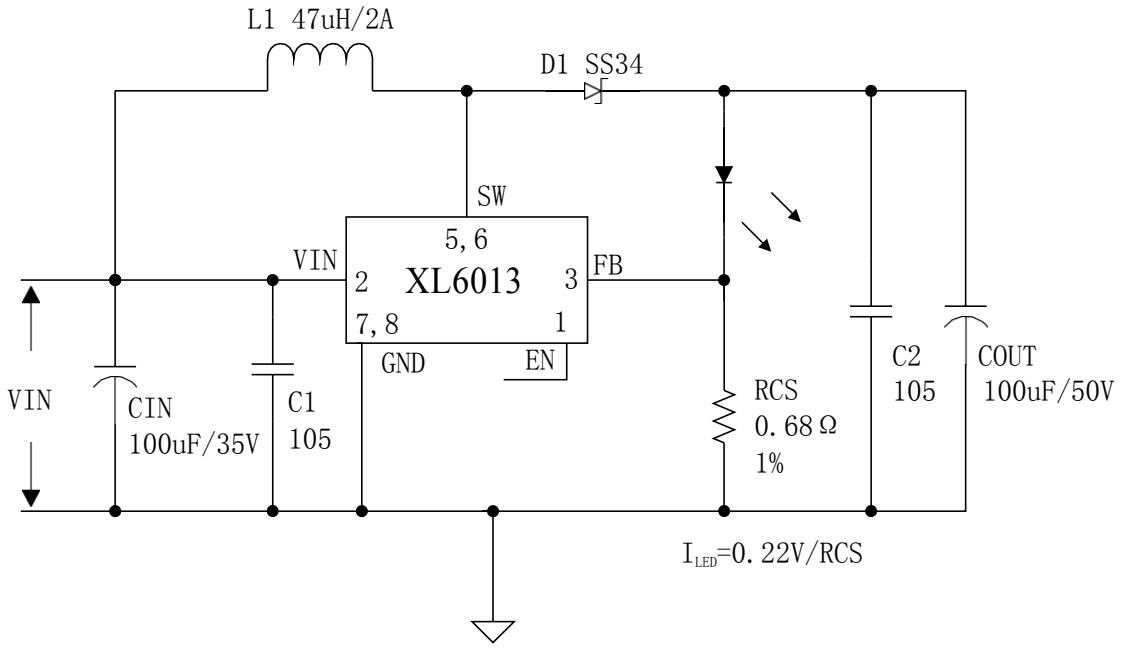


Figure4. XL6013 Typical Application Circuit

Ordering Information

Order Information	Marking ID	Package Type	Packing Type Supplied As
XL6013E1	XL6013E1	SOP8L	2500 Units on Tape & Reel

XLSEMI Pb-free products, as designated with "E1" suffix in the par number, are RoHS compliant.

Absolute Maximum Ratings（Note1）

Parameter	Symbol	Value	Unit
Input Voltage	Vin	-0.3 to 45	V
Feedback Pin Voltage	V_{FB}	-0.3 to Vin	V
EN Pin Voltage	V_{EN}	-0.3 to Vin	V
Output Switch Pin Voltage	V_{Output}	-0.3 to 60	V
Power Dissipation	P_D	Internally limited	mW
Thermal Resistance (SOP8) (Junction to Ambient, No Heatsink, Free Air)	R_{JA}	100	ºC/W
Maximum Junction Temperature	T_J	-40 to 150	ºC
Operating Junction Temperature	T_J	-40 to 125	ºC
Storage Temperature	T_{STG}	-65 to 150	ºC
Lead Temperature (Soldering, 10 sec)	T_{LEAD}	260	ºC
ESD (HBM)		>2000	V

Note1: Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

XL6013 Electrical Characteristics

T_a = 25℃;unless otherwise specified.

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
System parameters test circuit figure4						
VFB	Feedback Voltage	Vin = 5V to 12V, Vout=24V Iload=100mA	213.4	220	226.6	mV
ŋ	Efficiency	Vin=12V ,Vout=24V Iout=0.3A	-	93	-	%

Electrical Characteristics (DC Parameters)

Vin = 12V, GND=0V, Vin & GND parallel connect a 100uf/50V capacitor; Iout=100mA, T_a = 25℃; the others floating unless otherwise specified.

Parameters	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Input operation voltage	Vin		5		40	V
Shutdown Supply Current	I_{STBY}	V_{EN}=0V		70	100	uA
Quiescent Supply Current	I_q	V_{EN} =2V, V_{FB}=Vin		2.5	5	mA
Oscillator Frequency	Fosc		320	400	480	KHz
SW OVP	V_{SW}	V_{FB}=0V		60		V
Switch Current Limit	I_L	V_{FB} =0V		2		A
Output Power NMOS	Rdson	Vin=12V, I_{SW}=2A		110	120	mohm
EN Pin Threshold	V_{EN}	High (Regulator ON)		1.4		V
		Low (Regulator OFF)		0.8		
EN Pin Input Leakage Current	I_H	V_{EN} =2V (ON)		3	10	uA
	I_L	V_{EN} =0V (OFF)		3	10	uA
Max. Duty Cycle	D_{MAX}	V_{FB}=0V		90		%

Typical System Application (Recommend output voltage safe work range)

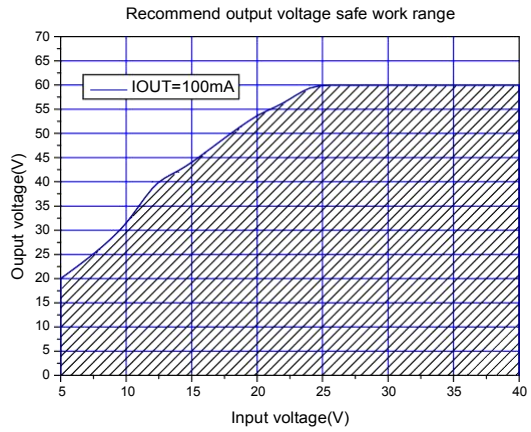


Figure5.Max output voltage(IOUT=100mA)

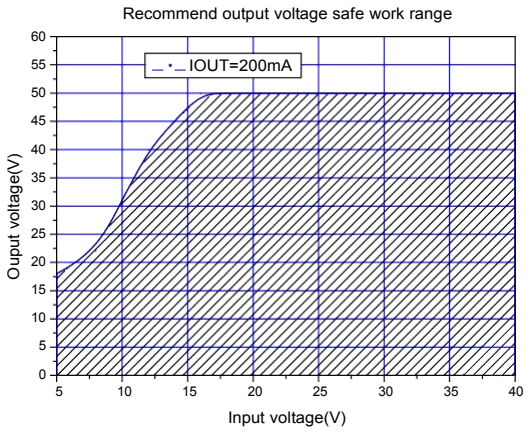


Figure6.Max output voltage(IOUT=200mA)

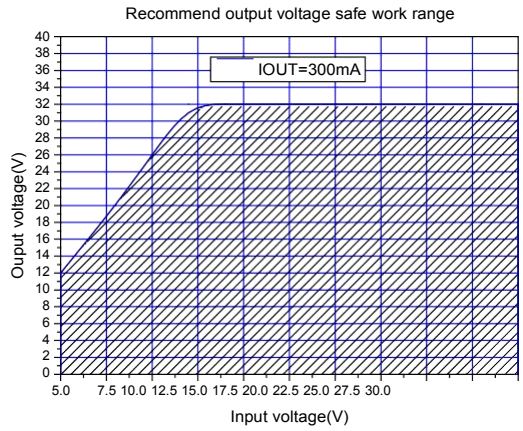


Figure7.Max output voltage(IOUT=300mA)

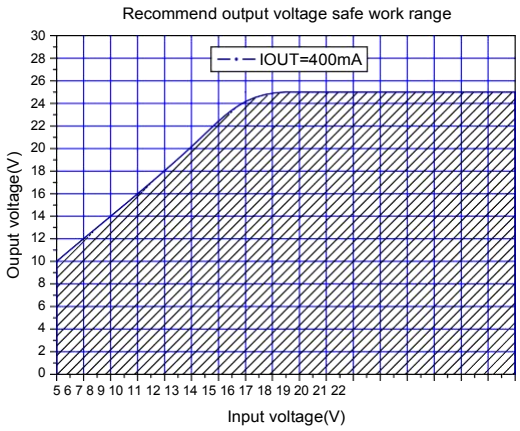


Figure8.Max output voltage(IOUT=400mA)

Typical System Application (VIN=5V~40V, IOUT=150mA)

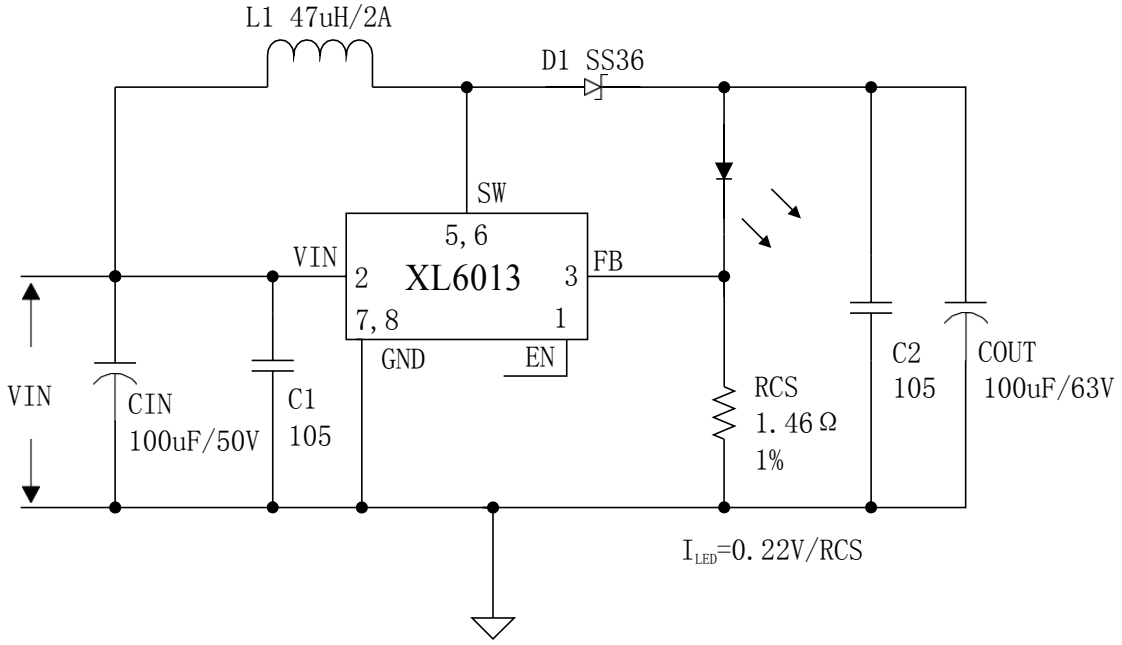


Figure9. XL6013 System Parameters Test Circuit (VIN=5V~40V, IOUT=150mA)

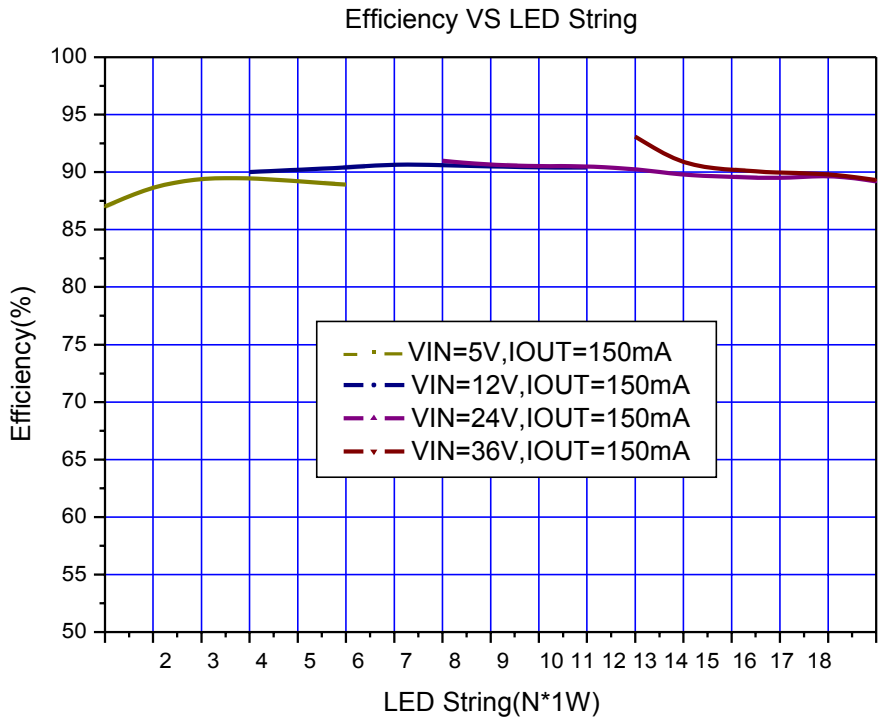


Figure10. XL6013 System Efficiency Curve

Typical System Application (VIN=5V~30V, IOUT=320mA)

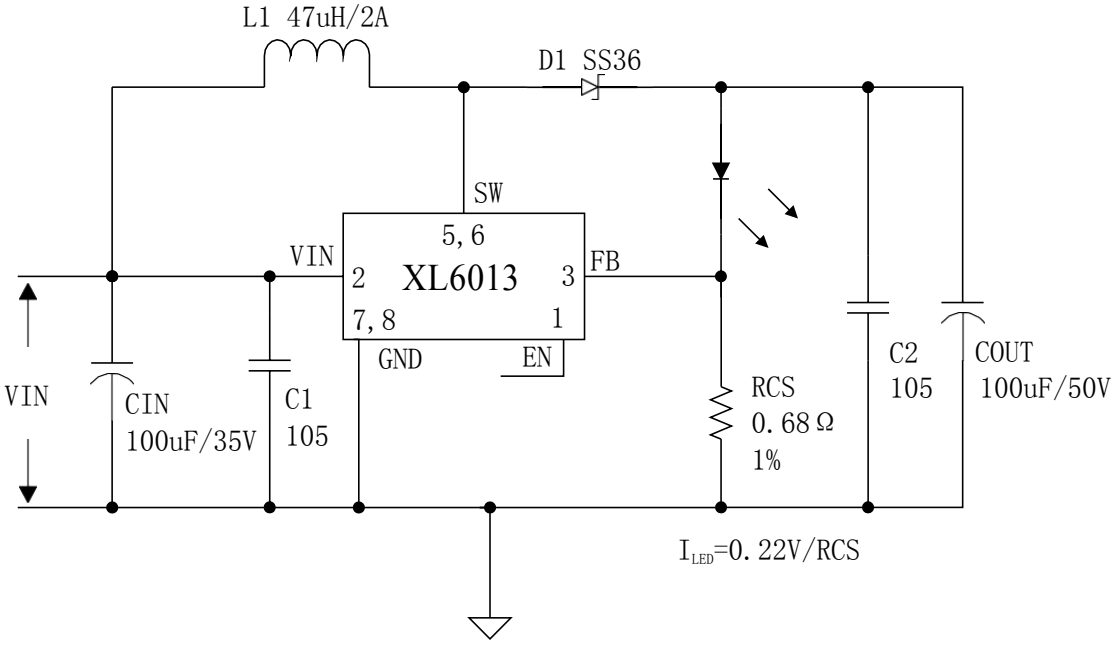


Figure11. XL6013 System Parameters Test Circuit (VIN=5V~30V, IOUT=320mA)

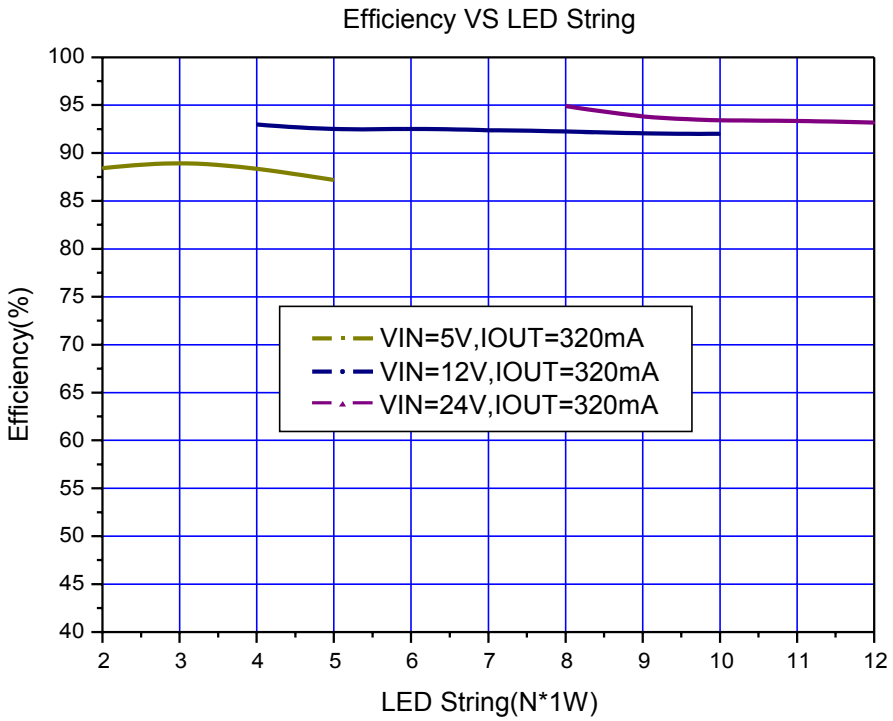


Figure12. XL6013 System Efficiency Curve

Typical System Application for SEPIC Buck-Boost LED Driver

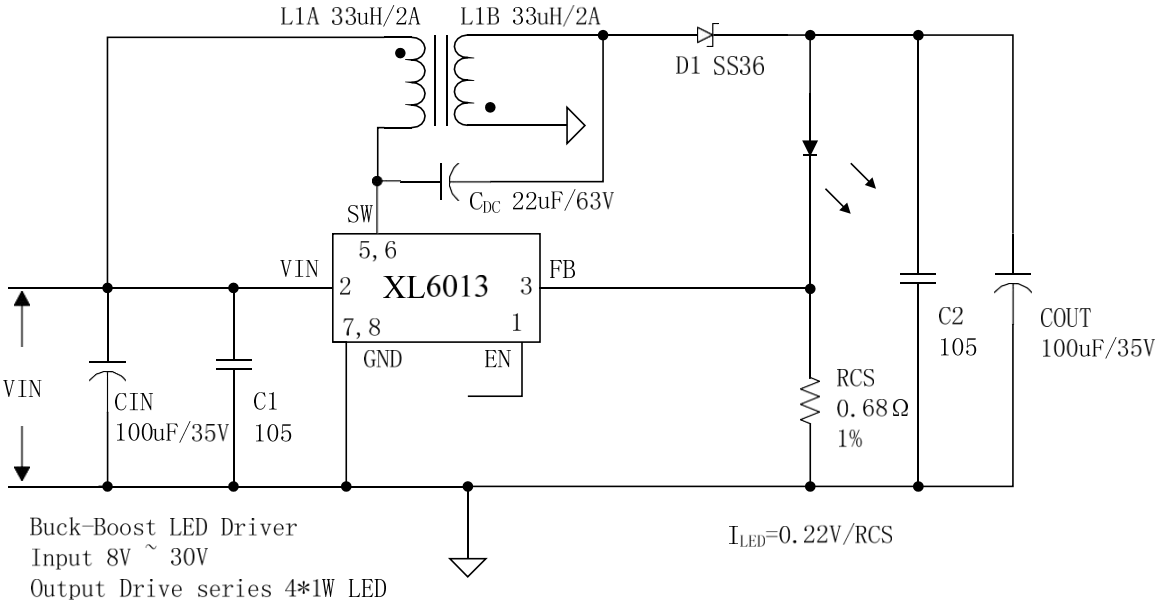


Figure13. XL6013 System Parameters Test Circuit (Buck-Boost LED Driver)

Typical System Application (PWM DIMMING)

PWM dimming function can be used in typical system application with external components. Changing the duty cycle of PWM signal can get different LED current. The PWM signal voltage is 3.3V or 5V.

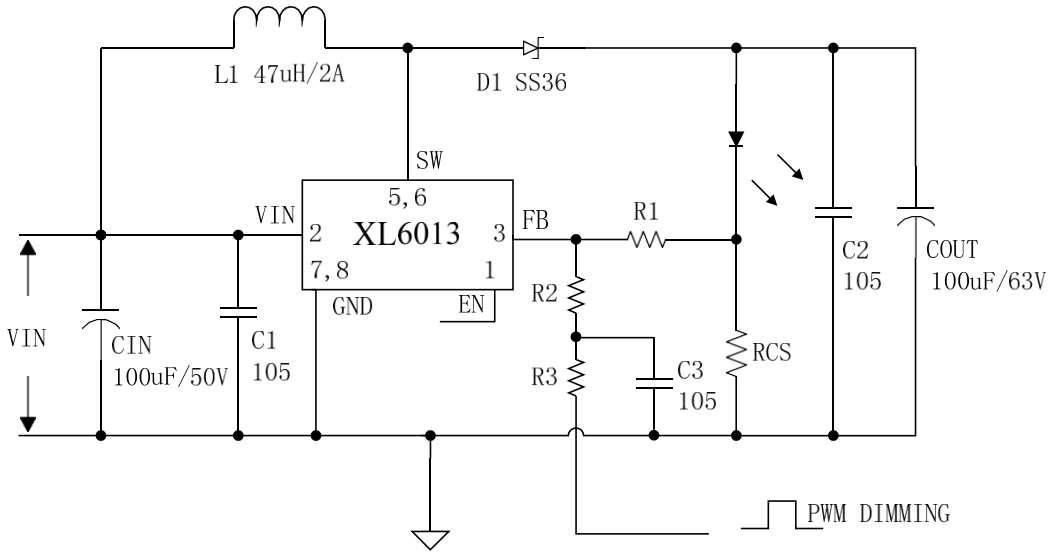


Figure14. XL6013 System Parameters Test Circuit (PWM DIMMING)

Typical System Application (LED OVP)

LED OVP function can be used in typical system application with external components. The output voltage can be limited in a suitable value by choose different zener diode when the output LED open. the zener diode voltage choosed by output led voltage's 1.3 times.

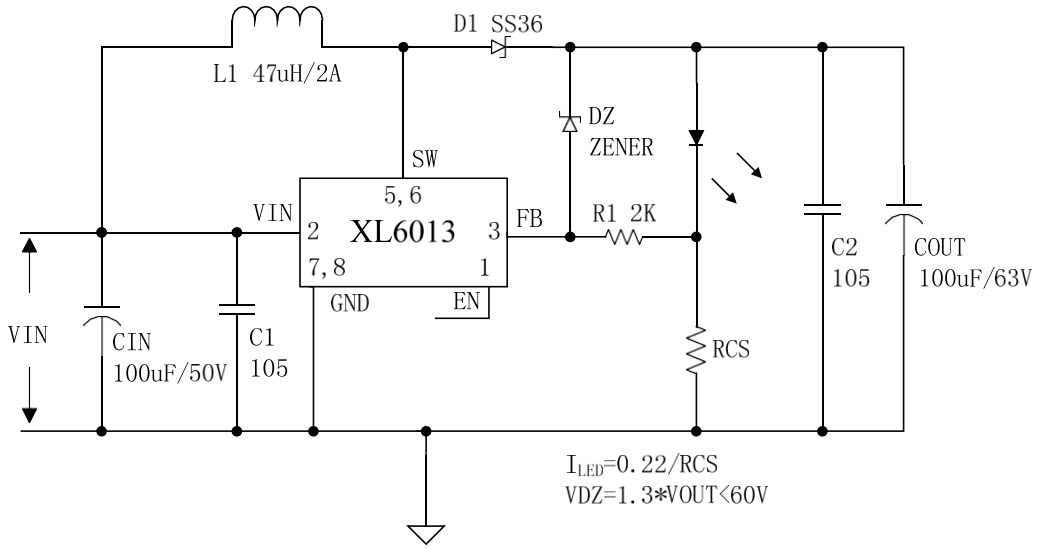
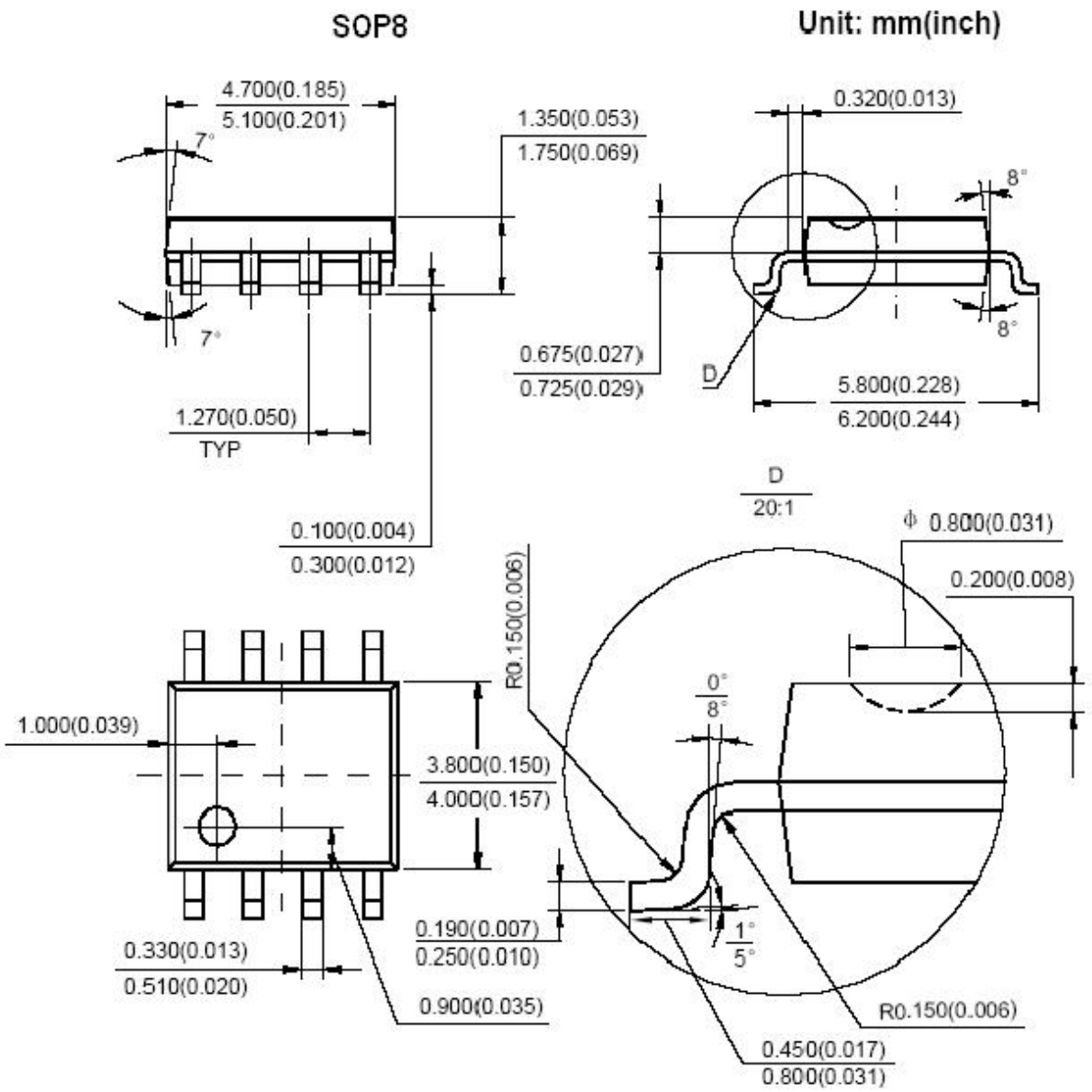


Figure15. XL6013 System Parameters Test Circuit (LED OVP)

Package Information

SOP8 Package Mechanical Dimensions



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